Triacs BT134W series

GENERAL DESCRIPTION

Glass passivated triacs in a plastic envelope suitable for surface mounting, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor industrial and domestic heating and static switching.

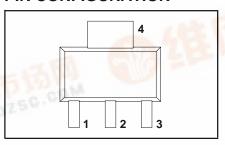
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
= 括岡	BT134W- BT134W- BT134W-	500 500F 500G	600 600F 600G	800 800F 800G	
V_{DRM}	Repetitive peak off-state	500	600	800	V
I _{T(RMS)}	voltages RMS on-state current	1	1	1	Α
I _{TSM}	Non-repetitive peak on-state current	10	10	10	Α

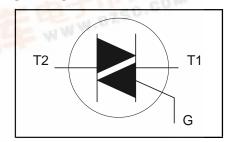
PINNING - SOT223

PIN	DESCRIPTION				
1	main terminal 1				
2	main terminal 2				
3	gate				
tab	main terminal 2				

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	THE.	MAX.		UNIT
V_{DRM}	Repetitive peak off-state voltages	- AM 67 213	14	-500 500 ¹	-600 600 ¹	-800 800	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{sp} \le 108$ °C full sine wave; $T_j = 25$ °C prior to surge	-		1		А
4000	M. M. A.	t = 20 ms	-		10		A
l²t dl _⊤ /dt	I ² t for fusing Repetitive rate of rise of on-state current after	t = 16.7 ms t = 10 ms $I_{TM} = 1.5 \text{ A}; I_{G} = 0.2 \text{ A};$ $dI_{G}/dt = 0.2 \text{ A}/\mu\text{s}$	-		11 0.5		A A ² s
	triggering	T2+ G+ T2+ G- T2- G- T2- G+	隀	WW	50 50 50 10		A/μs A/μs A/μs A/μs
$\begin{matrix} I_{GM} \\ V_{GM} \\ P_{GM} \\ P_{G(AV)} \\ T_{stg} \\ T_{i} \end{matrix}$	Peak gate current Peak gate voltage Peak gate power Average gate power Storage temperature Operating junction	over any 20 ms period	- - - -40		2 5 5 0.5 150 125		A V W V C C

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-sp}	Thermal resistance junction to solder point	full or half cycle	-	-	15	K/W
R _{th j-a}	Thermal resistance junction to ambient	pcb mounted; minimum footprint pcb mounted; pad area as in fig:14	- -	156 70	- -	K/W K/W

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	. MAX.			UNIT
		BT134W-				F	G	
I _{GT}	Gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$ T2+ G+	_	5	35	25	50	mA
		T2+ G-	-	8	35	25	50	mA
		T2- G- T2- G+	-	11 30	35 70	25 70	50 100	mA mA
IL	Latching current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$						
		T2+ G+ T2+ G-	-	7 16	20 30	20 30	30 45	mA mA
		T2- G-	-	5	20	20	30	mA
	Holding current	T_2 - G+ $V_D = 12 V; I_{GT} = 0.1 A$	-	7 5	30 15	30 15	45 30	mA mA
I _H	Tribiding current	$V_D = 12 \text{ V}, I_{GT} = 0.1 \text{ A}$	_	3	15		30	ł
$\bigvee_{\mathbf{V}}$	On-state voltage	$I_T = 2 A$	-	1.2		1.50		V V
V _{GT}	Gate trigger voltage	$\dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$ $\dot{V}_{D} = 400 \text{ V}; I_{T} = 0.1 \text{ A};$	0.25	0.7 0.4		1.5 -		l v
I _D	Off-state leakage current	$T_{j} = 125 \text{ °C}$ $V_{D} = V_{DRM(max)}$; $T_{j} = 125 \text{ °C}$	-	0.1		0.5		mA

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS		MIN.		TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	BT134W- $V_{DM} = 67\% V_{DRM(max)};$ $T_j = 125 °C;$ exponential waveform; gate open	 100	F 50	G 200	250	-	V/μs
dV _{com} /dt	Critical rate of change of commutating voltage	circuit $V_{DM} = 400 \text{ V}; T_j = 95 ^{\circ}\text{C};$ $I_{T(RMS)} = 1 \text{ A};$ $dI_{com}/dt = 1.8 \text{ A/ms}; \text{ gate}$	-	-	10	50	-	V/μs
t _{gt}	Gate controlled turn-on time	open circuit $I_{TM} = 1.5 \text{ A};$ $V_D = V_{DRM(max)};$ $I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu s;$	-	-	-	2	-	μs

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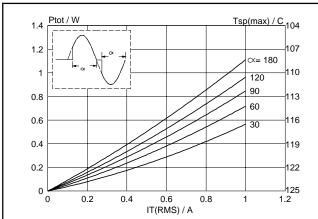


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where α = conduction angle.

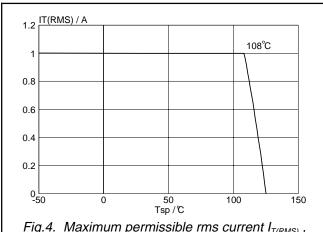


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus solder point temperature T_{sp} .

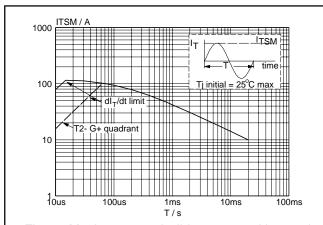


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \le 20$ ms.

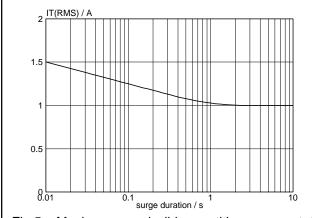


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{sp} \le 108$ °C.

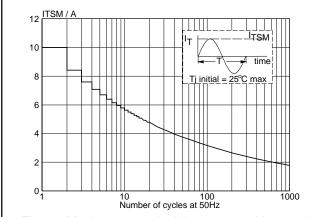


Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

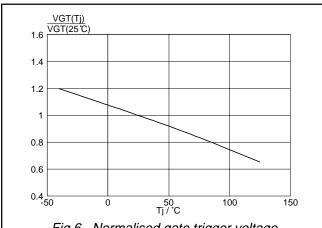
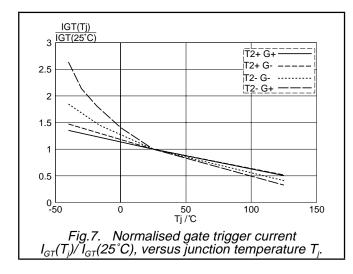
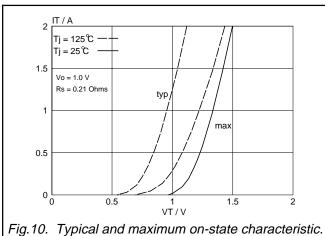
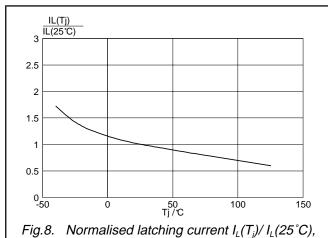


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25^{\circ}C)$, versus junction temperature $T_{j\cdot}$

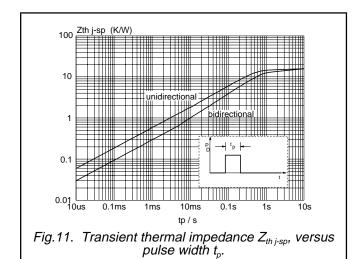
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versus junction temperature T



IH(Tj) 3 IH(25°C) 2 1.5 0.5

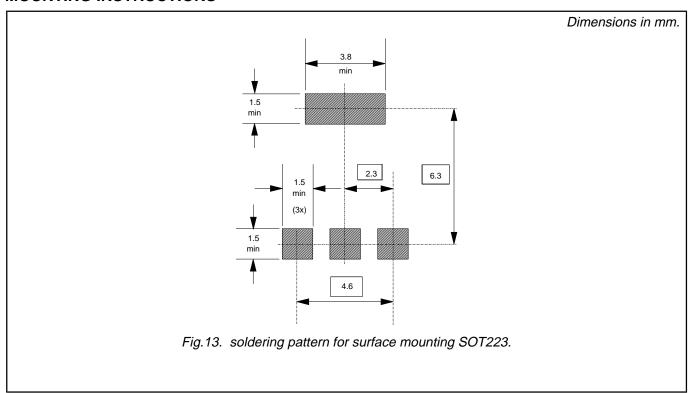
1000 off-state dV/dt limit BT134 SERIES 100 10 dlcom/dt = 5.1A/ms

Fig.9. Normalised holding current $I_H(T_i)/I_H(25^{\circ}C)$, versus junction temperature T_i .

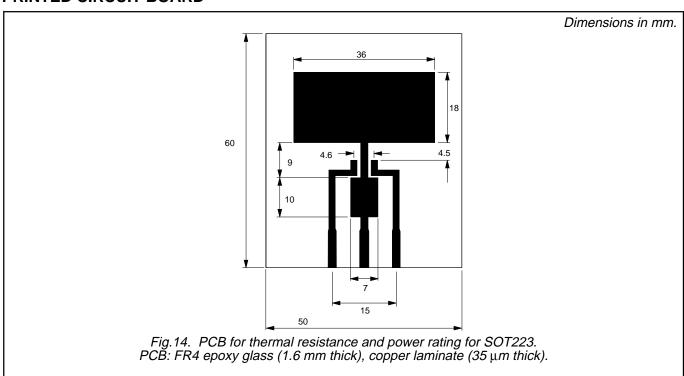
Fig.12. Typical commutation dV/dt versus junction temperature, parameter commutation dl_T/dt. The triac should commutate when the dV/dt is below the value on the appropriate curve for pre-commutation dl_r/dt.

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MOUNTING INSTRUCTIONS



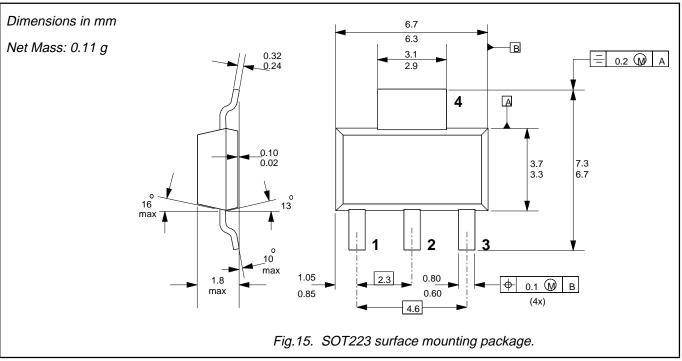
PRINTED CIRCUIT BOARD



Product specification Philips Semiconductors

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MECHANICAL DATA



Notes

- For further information, refer to Philips publication SC18 " SMD Footprint Design and Soldering Guidelines".
 Order code: 9397 750 00505.
 Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status						
Objective specification	This data sheet contains target or goal specifications for product development.					
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.					
Product specification	This data sheet contains final product specifications.					
1 Toddot Specification	Triis data siloot contains iiriai product specifications.					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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